ABOCIATION CONNECTING ELECTRONICS INDUSTRIES OF INTERNATIONAL AND	C. Bannockb	urn. Illinois. A	Il rights reserved u ntions.	nder both	This docum level parts, t	ent is a declaration entities the declaration entities and the declaration entities and the declaration entities and the declaration entities are an entities and the declaration entities are an entities and the declaration entities are an entite are an entities are an entities are an entite are	on of the sub- ncompasses a	stances w all lower	vithin the manufacture level materials for wh	er listed	item. Note: if nanufacturer	the item is an as has engineering	ssembly with lower responsibility.
				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and I					als and N	Ifg Information	on	
Supplier Information													
Company name*			Company unique ID			Unique ID Authority				Response Date*			
onsemi								2024-05-21					
Contact Name Title - Contact					Phone - Contact*				Email - Contact*				
Product-Env-Stewards Product Enviro			viro Compliance			NA				Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Repres			esentative			Phone - Representative*			Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item Number		Mfr Item Name			Effective Date	Version	М	Manufacturing Site		Weight*	UOM	Unit Type
	CS51221	CS51221EDR16G ANA PWM VOLTA		TAGE MODE (CNTR	2024-05-21		PH1			142.69	mg	Each
Manufacturing Proccess Informati	on												
Terminal Plating / Grid Array Mate	Terminal Plating / Grid Array Material Terminal Base Alloy		J-STD-020 MSL	Rating	Peak Proce	ss Body Ten	nperature	e Max Time at Peak	Tempera	ture Numbe	er of Reflow Cy	cles	
Matte Tin (Sn) - annealed CU Alloy		1	1		260	0	2	30	seco	nds 3			
Comments													
evel 1 - maximum time at peak temperature	e during sol	dering is 10-3	0 seconds										
or more information regarding material co	mposition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP). aterial (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury,											
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ess of the applicable quantity limit identified about the may apply. If the part is an assembly with low is accuracy and that such information is true and ce of its products with European Union member we independently verified such information. How	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted								
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.												
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	stislav Drska	Le										

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

signs range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	2.73	mg	Supplier	Silicon (Si)	7440-21-3		2.73	mg	
Die Attach	4.85	mg	Supplier	Silver (Ag)	7440-22-4		3.6375	mg	
			Supplier	Epoxy resins	129915-35-1		1.2125	mg	
Lead Frame	75.92	mg	Supplier	Silver (Ag)	7440-22-4		0.7592	mg	
			Supplier	Zinc (Zn)	7440-66-6		0.1518	mg	
			Supplier	Iron (Fe)	7439-89-6		1.9739	mg	
			Supplier	Copper (Cu)	7440-50-8		73.035	mg	
Mold Compound-Black	55.11	mg		Epoxy Phenol Resin	proprietary data		5.7866	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		49.3234	mg	
Plating	3.73	mg	Supplier	Tin (Sn)	7440-31-5		3.73	mg	
Wire Bond - Au	0.35	mg	Supplier	Gold (Au)	7440-57-5		0.35	mg	

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 signar range of distribution unless otherwise noted)